Docket No.

240708US2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Kenichi HAYASHI, et al.

DEC 2 8 2005

SERIAL NO:

10/625,583

GAU:

2826

FILED:

July 24, 2003

EXAMINER: Williams, A.

FOR:

SEMICONDUCTOR DEVICE AND SEMICONDUCTOR ASSEMBLY MODULE

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- The applicant(s) wish to make of record the references cited in a Chinese and Japanese Office Action and listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- □ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,

MAIER & NEUSTADT, P.C.

Eckhard H. Kuesters Registration No. 28,870

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22850

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Remus F. Fetea, Ph.D.

Limited Recognition No. L0037

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LIST OF	KEFE	RENCES CITED BY APP	PLICANT	Kenichi HAYASHI, et al.			
				FILING DATE		GROUP	
				July 24, 2003		2826	
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS SUB FILING DATE IF APPROPRIATE		
	AA	5,096,425	3/17/1992	Takahashi			
	AB						
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FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY		TRANSLATION YES NO	
	AO	63-166254	7/9/1988	Japan (w/English Abstract)			X
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OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)							
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Examiner					Date Considered		
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in							
conformance	and no	t considered. Include co.	ny of this form	with next communication to applicant	o,		20011 11 1101 111